NOVEMBER 1986 - REVISED SEPTEMBER 1997

TELECOMMUNICATION SYSTEM SECONDARY PROTECTION

- **Ion-Implanted Breakdown Region**
  Precise and Stable Voltage
  Low Voltage Overshoot under Surge

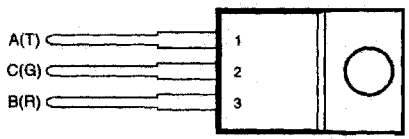
DEVICE	$V_{(Z)}$ V	$V_{(BO)}$ V
'3082	58	82

- **Planar Passivated Junctions**
  Low Off-State Current < 10 µA
- **Rated for International Surge Wave Shapes**

WAVE SHAPE	STANDARD	I_{TSP} A
8/20 µs	ANSI C62.41	150
10/160 µs	FCC Part 68	60
10/560 µs	FCC Part 68	45
0.2/310 µs	RLM 88	38
10/700 µs	FTZ R12	50
	VDE 0433	50
	CCITT IX K17/K20	50
10/1000 µs	REA PE-60	40

- **UL Recognized, E132482**

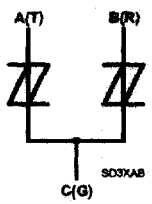
TO-220 PACKAGE
(TOP VIEW)



Pin 2 is in electrical contact with the mounting base.

MDXXANA

device symbol



description

The TISP3082 is designed specifically for telephone equipment protection against lightning and transients induced by a.c. power lines. These devices consist of two bidirectional suppressor elements connected to a Common (C) terminal. These devices will supress voltage transients between terminals A and C, B and C, and A and B.

Transients are initially clipped by zener action until the voltage rises to the breakover level, which causes the device to crowbar. The high crowbar holding current prevents d.c. latchup as the transient subsides.

These monolithic protection devices are fabricated in ion-implanted planar structures to ensure precise and matched breakover control and are virtually transparent to the system in normal operation.

absolute maximum ratings at 25°C case temperature (unless otherwise noted)

RATING		SYMBOL	VALUE	UNIT
Non-repetitive peak on-state pulse current (see Notes 1, 2 and 3)				
	8/20 µs (ANSI C62.41, open-circuit voltage wave shape 1.2/50 µs)		150	
	10/160 µs (FCC Part 68, open-circuit voltage wave shape 10/160 µs)		60	
	5/200 µs (VDE 0433, open-circuit voltage wave shape 2 kV, 10/700 µs)		50	
	0.2/310 µs (RLM 88, open-circuit voltage wave shape 1.5 kV, 0.5/700 µs)	I_{TSP}	38	A
	5/310 µs (CCITT IX K17/K20, open-circuit voltage wave shape 2 kV, 10/700 µs)		50	
	5/310 µs (FTZ R12, open-circuit voltage wave shape 2 kV, 10/700 µs)		50	
	10/560 µs (FCC Part 68, open-circuit voltage wave shape 10/560 µs)		45	
	10/1000 µs (REA PE-60, open-circuit voltage wave shape 10/1000 µs)		40	
Non-repetitive peak on-state current, 50 Hz, 2.5 s (see Notes 1 and 2)		I_{TSM}	10	A rms
Initial rate of rise of on-state current, Linear current ramp, Maximum ramp value < 38 A		di_T/dt	250	A/µs
Junction temperature		T_J	150	°C
Operating free - air temperature range			0 to 70	°C
Storage temperature range		T_{stg}	-40 to +150	°C
Lead temperature 1.5 mm from case for 10 s		T_{lead}	260	°C

NOTES: 1. Above 70°C, derate linearly to zero at 150°C case temperature
2. This value applies when the initial case temperature is at (or below) 70°C. The surge may be repeated after the device has returned to thermal equilibrium.
3. Most PTT's quote an unloaded voltage waveform. In operation the TISP essentially shorts the generator output. The resulting loaded current waveform is specified.

electrical characteristics for the A and B terminals, T_J = 25°C

PARAMETER		TEST CONDITIONS			MIN	TYP	MAX	UNIT
V_Z	Reference zener voltage	I_Z = ± 1mA			± 116			V
I_D	Off-state leakage current	V_D = ± 50 V					± 10	µA
C_{off}	Off-state capacitance	V_D = 0	f = 1 kHz	(see Note 4)		0.5	5	pF

NOTE 4: These capacitance measurements employ a three terminal capacitance bridge incorporating a guard circuit. The third terminal is connected to the guard terminal of the bridge.

electrical characteristics for the A and C or the B and C terminals, T_J = 25°C

PARAMETER		TEST CONDITIONS			MIN	TYP	MAX	UNIT
V_Z	Reference zener voltage	I_Z = ± 1mA			± 58			V
$^{\infty}V_Z$	Temperature coefficient of reference voltage					0.1		%/°C
$V_{(BO)}$	Breakover voltage	(see Notes 5 and 6)					± 82	V
$I_{(BO)}$	Breakover current	(see Note 5)			± 0.15		± 0.8	A
V_{TM}	Peak on-state voltage	I_T = ± 5 A	(see Notes 5 and 6)			± 2.2	± 3	V
I_H	Holding current	(see Note 5)			± 150			mA
dv/dt	Critical rate of rise of off-state voltage	(see Note 7)					± 5	kV/µs
I_D	Off-state leakage current	V_D = ± 50 V					± 10	µA
C_{off}	Off-state capacitance	V_D = 0	f = 1 kHz	(see Note 4)		110	200	pF

NOTES: 5. These parameters must be measured using pulse techniques, t_w = 100 µs, duty cycle ≤ 2%.
6. These parameters are measured with voltage sensing contacts seperate from the current carrying contacts located within 3.2 mm (0.125 inch) from the device body.
7. Linear rate of rise, maximum voltage limited to 80 % V_Z (minimum)..

PARAMETER MEASUREMENT INFORMATION

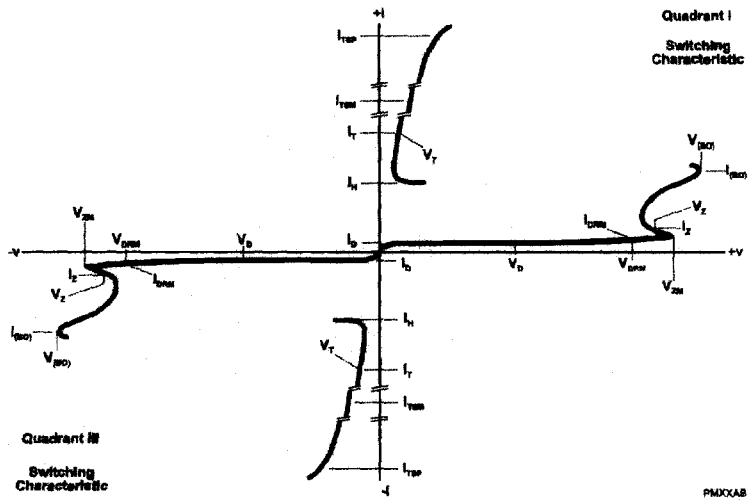


Figure 1. VOLTAGE-CURRENT CHARACTERISTIC FOR ANY PAIR TERMINALS

thermal characteristics

PARAMETER		MIN	TYP	MAX	UNIT
$R_{\theta JA}$	Junction to free air thermal resistance			62.5	°C/W

TYPICAL CHARACTERISTICS
A and C, or B and C terminals

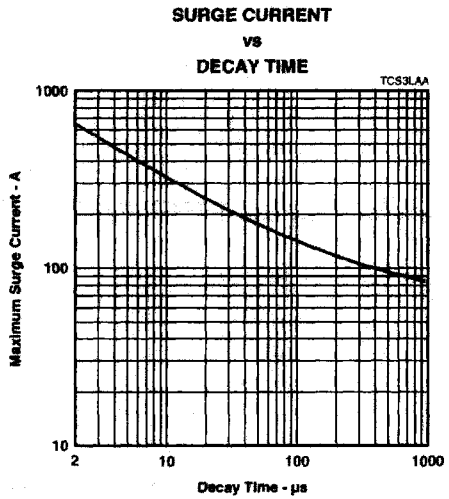


Figure 2.